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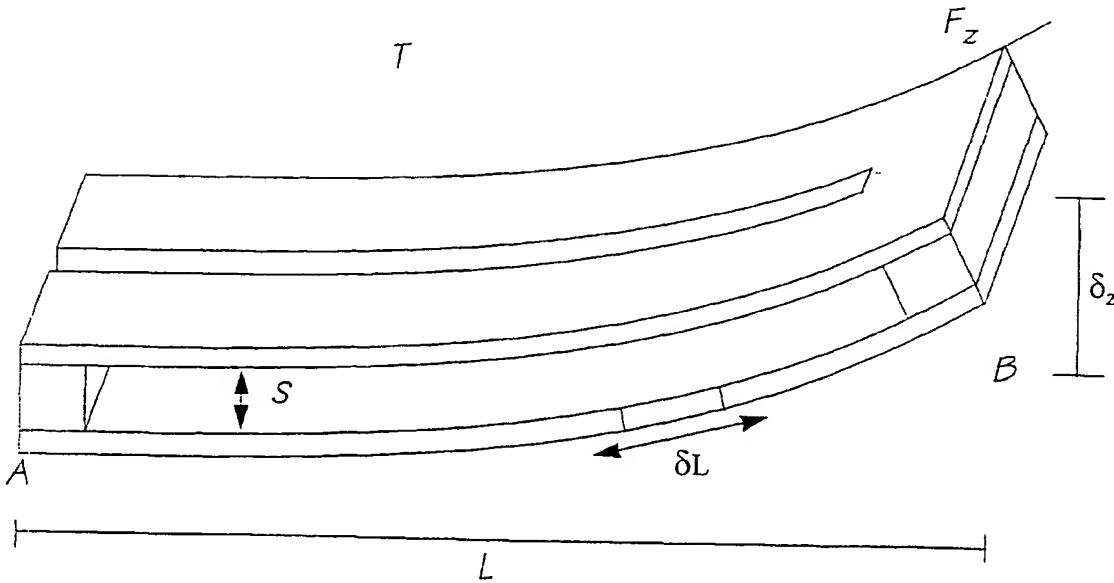
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(54) Title: THERMOELASTIC ACTUATOR DESIGN



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(57) Abstract: The invention concerns design of thermoelastic actuators incorporating an expansive element formed from material selected in accordance with a procedure involving the derivation of an indicator of the material's potential effectiveness for each application. Indicator ϵ is derived from: $\epsilon = E\gamma^2 T / \rho C$ where E is Young's modulus of the material, γ is coefficient of thermal expansion, T is maximum operating temperature, ρ is density and C is specific heat capacity. Elements may be selected from a group including: borides, carbides, nitrides or silicides of chromium, molybdenum, niobium, tantalum, titanium, tungsten, vanadium or zirconium.

THERMOELASTIC ACTUATOR DESIGN

Co-Pending Applications

Various methods, systems and apparatus relating to the present invention are disclosed in the following co-pending applications filed by the applicant or assignee of the present invention on 24 May 2000:

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	PCT/AU00/00538,	PCT/AU00/00539,	PCT/AU00/00540,	PCT/AU00/00541,
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	PCT/AU00/00547,	PCT/AU00/00546,	PCT/AU00/00554,	PCT/AU00/00556,
	PCT/AU00/00557,	PCT/AU00/00558,	PCT/AU00/00559,	PCT/AU00/00560,
15	PCT/AU00/00561,	PCT/AU00/00562,	PCT/AU00/00563,	PCT/AU00/00564,
	PCT/AU00/00565,	PCT/AU00/00566,	PCT/AU00/00567,	PCT/AU00/00568,
	PCT/AU00/00569,	PCT/AU00/00570,	PCT/AU00/00571,	PCT/AU00/00572,
	PCT/AU00/00573,	PCT/AU00/00574,	PCT/AU00/00575,	PCT/AU00/00576,
	PCT/AU00/00577,	PCT/AU00/00578,	PCT/AU00/00579,	PCT/AU00/00581,
20	PCT/AU00/00580,	PCT/AU00/00582,	PCT/AU00/00587,	PCT/AU00/00588,
	PCT/AU00/00589,	PCT/AU00/00583,	PCT/AU00/00593,	PCT/AU00/00590,
	PCT/AU00/00591,	PCT/AU00/00592,	PCT/AU00/00594,	PCT/AU00/00595,
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25 Field of the Invention

The present invention relates to materials potentially suitable for use as the expansive element in thermoelastic design and to methods for ranking the potential relative suitabilities of those materials.

30 The invention as developed originally as a means of identifying and ranking a range of materials that potentially may exhibit superior properties for use in the manufacture of

microscopic thermal bend actuators for use in micro-electro mechanical systems (MEMS), and will be described hereinafter with reference to this field. However, it will be appreciated that the invention is not limited to this particular use and is equally applicable to macroscopic design even though the overall design considerations are vastly different

5 and certainly less complex.

Background of the Invention

It is important to clarify that thermoelastic actuation is characterized using force, deflection and temperature as opposed to switching, which is characterized using deflection and temperature rise alone. Macroscopic thermoelastic actuators are typically used as

10 switches that activate other more energy efficient actuation systems, however, microscopic thermoelastic actuators are an attractive actuation mechanism for a number of reasons. This includes the down scaling of certain physical phenomena. For example, it is possible to fabricate very thin films that decrease the thermal mass and minimize efficiency losses. Opposing gravitational and inertial forces become negligible on the microscopic scale.

15 Other advantages include ease of fabrication (although more complex than simple electrostatic actuators) and the possibility of low voltage operation. Disadvantages include a low operational bandwidth determined by the thermal conductivities of substrate materials - this is more of an advantage for the current application allowing for rapid firing.

A relatively diverse range of output force and deflection values can be obtained by

20 altering actuator geometry. However, the fundamental operation of actuation is directly related to the mechanical and thermal properties of the component materials. Correct material selection in association with effective design can result in either a smaller or a more efficient actuator. Such an actuator increases wafer yield and is thus more commercially viable. A more efficient actuator may be battery powered increasing operation simplicity

25 and negating the requirement for expensive voltage transformers. An increase in thermal efficiency improves the operational firing frequency, and decreases the possibility of thermal crosstalk. This is especially relevant for arrays of thermal actuators in a micro-cilia device.

However, material selection for MEMS application is not straightforward. Firstly,

30 published thin film properties can vary greatly due to different fabrication methods and difficulties associated with experimentally quantifying material properties on the

microscopic scale. Secondly, certain thin films can only be fabricated with certain layer thicknesses because inherent stress can shatter or curl the substrate wafer. Thirdly, only certain materials can be used in the fabrication process at most fabs as the introduction of a new material can contaminate machinery.

5 Progress to date

Until recently, the only materials regularly used or considered for use in such applications were polysilicon, single crystal silicon. However, the applicant just previously made the surprising discovery that titanium nitride and titanium boride/diboride exhibited excellent properties relevant to this application.

10 Realising the breakthrough this surprising discovery signified, the applicant sought to try and identify possible alternatives in order to provide designers of thermoelastic systems with more choice and flexibility. However, given the lack of available data on their film properties for various materials and the fact that empirical testing with MEMS would be prohibitively expensive, there was clearly a need, or it was at least highly desirable to be
15 able to determine a method of evaluating materials for this use based solely on the commonly available macro material properties.

Summary of the Invention

It is therefore an ultimate object of one aspect of this invention to identify a range of alternative materials that will potentially exhibit superior properties for use in thermoelastic
20 design and of another aspect to provide a means of ranking the potential suitability of a given range of materials for this same use.

According to a first aspect of the invention there is provided a method of selecting a material for use as the expansive element in a thermoelastic design by deriving an indicator of the material's potential effectiveness for that use, said method including the step of
25 calculating a dimensionless constant $\varepsilon\gamma$ for that material in accordance with the formula:

$$\varepsilon\gamma = \frac{E\gamma^2 T}{\rho C}$$

wherein E is the Young's modulus of the material; γ is the coefficient of thermal expansion; T is the maximum operating temperature, ρ is the density and C is the specific heat capacity.

Preferably, the method of selection includes the step of normalising the dimensionless constant relative to that of silicon to a value ϵ which is achieved by deriving the value ϵ_Y for the material of interest at the relevant temperature value and dividing this by the value of ϵ obtained for silicon at that same temperature.

5 The relevant maximum operating temperature will depend upon the surrounding materials and their function but is most commonly the oxidising temperature or the melting point temperature.

Desirably, the selection method includes the step of eliminating certain materials by requiring a pre-determined resistivity range. In one preferred form this resistivity range is
10 between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$.

In accordance with a third aspect of the invention there is provided an expansive element in a thermoelastic design that is made from any functionally suitable material or combinations of materials selected from a group including:

silicides and carbides of titanium.

15 In accordance with a fourth aspect of the invention there is provided an expansive element in a thermoelastic design that is made from any functionally suitable material or combinations of materials selected from a group including:

borides, silicides, carbides and nitrides of tantalum, molybdenum, niobium, chromium, tungsten, vanadium, and zirconium.

20 In accordance with a fifth aspect of the invention there is provided an expansive element in a thermoelastic design that is made from any functionally suitable alloy material or combinations of alloy materials selected from the group including:

borides, silicides, carbides and nitrides of titanium, tantalum, molybdenum, niobium, chromium, tungsten, vanadium, and zirconium.

25 Preferably the expansive element in a thermoelastic design in accordance with the third, fourth or fifth aspect of the invention also includes one or more of the following properties:

- (a) a resistivity between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$;
- (b) chemically inert in air;
- 30 (c) chemically inert in the chosen ink; and
- (d) depositable by CVD, sputtering or other thin film deposition technique.

Brief Description of the Drawings

Derivation of the dimensionless constant ϵ of the first aspect of the invention, together with sample applications and examples of derived values of this constant and other properties for a range of materials, will now be described in detail with reference to the 5 accompanying drawings in which:

Figure 1 shows a schematic representation of a thermoelastic actuator;

Figure 2 shows a plot of longitudinal work versus heat energy for single material clamped/free titanium beam (length 20 μm , thickness 1 μm , width 5 μm);

Figure 3 shows a plot derived from Figure 2 of expansion efficiency versus 10 temperature efficiency for a clamped/free titanium beam; and

Figure 4 shows a comparison of mechanical work versus the heat energy of thermoelastic actuator fabricated from Titanium and Silicon.

Detailed Description

A non-dimensionalized material actuation efficiency is presented that assesses the 15 potential application of a material to thermoelastic design. The method is based on the material thermal and mechanical properties and assists in a structured approach of material selection for effective design.

The Material Actuation Efficiency

Actuators are characterized by a combination of deflection, force and operation 20 temperature in contrast to switches that are characterized by operation temperature and deflection alone. Fundamental thermoelastic design is characterized by the differential longitudinal expansion of two bonded layers. Thus, the expansion of isolated unbonded layers directly relates to global behaviour. A single material beam is used here to illustrate the material actuation efficiency. The approach is straightforward and relates to general 25 thermoelastic design. The derivation assumes that material properties are constant across the thermal range.

Equations 1 to 3 are fundamental thermomechanical equations describing the behaviour of simple single material beam subjected to a quantity of heat, Q as illustrated in Figure 1. Equation 1 describes the extension, δL , of a free/free beam and equation 2 30 describes the reaction force, F , of a clamped/clamped beam.

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$$\delta L = \gamma L_0 T \quad (\text{EQ 1})$$

Where: δL = extension of beam, L_0 = original length of beam, T = operation temperature (temperature rise), and γ = coefficient of thermal expansion of beam.

$$F = AE\gamma T \quad (\text{EQ2})$$

5 F = force exerted by beam expansion, A = cross sectional area of beam, E = Young's Modulus.

$$Q = V\rho C t \quad (\text{EQ3})$$

Where: Q = heat energy input, V = volume of beam, ρ = density, and C = specific heat capacity of beam.

10 Potential mechanical work is given by equation 4 and is defined as the product of the clamped beam force, F, and free beam deflection, δL . The quadratic relationship between the heat input and output mechanical work for the simple monolithic beam is shown in figure 18.

$$W = F\delta L \quad (\text{EQ4})$$

15 Where: W = mechanical work

Equation 5 describes the non-dimensional thermoelastic actuation efficiency and is formulated as the quotient of the mechanical work and heat energy as described by equations 3 and 4. The efficiency is independent of geometry and is a primary indication of a material's potential application to thermoelastic design. The linear relationship between the actuation efficiency and material temperature for the simple beam is shown in Figure 3. The graph indicates that high temperature operation is desirable for maximum efficiency. The plot is limited by the applicable operation temperature and therefore, different material plots are of different lengths. The assumption used in this text is that the operation temperature is the material melting point because it is indicative of the operable thermal range. Thus, the material actuation efficiency, ϵ , is defined as the actuation efficiency at the maximum operable temperature, T , of that material. The slope of the efficiency curve is a constant, m_ϵ and is defined in equation 6. The combination of ϵ and m_ϵ fully characterize a material's actuation characteristics non graphically.

$$\varepsilon = \frac{\text{Output Mechanical Work}}{\text{Heat Energy Input}} = \frac{E\gamma^2 T}{\rho C} \left[\frac{(N/m^2)(1/\text{ }^{\circ}\text{C}^2)(\text{ }^{\circ}\text{C})}{(\text{kg}/\text{m}^3)(\text{Nm}/\text{kg }^{\circ}\text{C})} \right] \quad (EQ5)$$

$$5 \quad m_\varepsilon = \frac{d\varepsilon}{dT} = \frac{E\gamma^2}{\rho C} \left[\frac{N/m^2 1/\text{ }^{\circ}\text{C}^2}{\text{kg}/\text{m}^3 \text{Nm}/\text{kg }^{\circ}\text{C}} \right] \quad (EQ6)$$

Material Selection

Different thin film materials including materials with extreme properties (PTFE - high g, Diamond - high E) and compounds from all the major CVD groups including borides, 10 silicides, nitrides and carbides is shown in Table 2. The efficiency values are scaled according to silicon efficiency values because the inclusion of scaled values greatly simplifies design equations described in the following text. The scaling or comparison of a material with respect to a reference material is an integral step in the material selection process. In addition, scaling also results in a more readable index as illustrated by the 15 following comparisons. Silicon is chosen as the reference material because of its predominance in lithographic fabrication.

Preliminary candidates for thermoelastic actuation can be selected according to efficiencies and slopes, however, it is important to note that two materials that have identical ε but differing m_ε will output different amounts of work for any constant geometry 20 (see Comparison 1 below, different amounts of heat energy are also required). Three important design parameters are defined here as heat input, work output and volume. A design matrix can be constructed by varying each parameter and can then be used to select suitable materials. The following comparisons are used to assemble the design matrix.

TABLE 2. Material Properties.

Material	α $10^{-6}/^{\circ}\text{C}$	E GPa	ρ kg/m^3	C $\text{J}/\text{kg}^{\circ}\text{C}$	$m_e/m_{r.c}$ $^{\circ}\text{C}^{-1}$	O.T. $^{\circ}\text{C}$	M.P. $^{\circ}\text{C}$	MN O.T.	MN M.P.	KXX W/m.K	R mW/m
Aluminum	23.1	68.9	2700	897	17.12		657		7.98	231	0.027
Boron Carbide	4.5	454	2520	955	4.31		2450		7.49	35	5e4
Chromium diBoride	11.1	540	5600	690	19.42	1000	2150	13.78	29.62	32	0.18
Chromium diSilicide	5.9		5600			1150	1560				0.8
Chromium Carbide	9.9	385	6680	530	12.02	1100	1895	9.38	16.16	19	0.75
Chromium Oxide	9.0	102	5210	730	2.45	1000	2603	1.74	4.52	30	13
Copper	16.5	110	8940	386	9.79		1085		7.53	398	0.017
Gold	14.2	80	19300	129	7.31		1064		5.52	315	0.023
Hafnium Carbide	6.3	410	12670	190	7.63	600	3930	3.24	21.25	13	0.4-0.6
Hafnium diBoride	7.6		11200	300		1500	3250			51	0.1
Hafnium diSilicide			8030			1100	1700				
Hafnium Monocarbide	6.5	424	11940				3890			8	0.5
Hafnium Nitride	6.5		13.940			500	3300			17	32
Molybdenum	4.8	343	10200	251	3.48		2623		6.48	138	
Molybdenum Boride	5	685	7480	530	4.87	1000	2140	3.46	7.40	27	0.18
Molybdenum Carbide	6.7	530	9120	315	9.34	500	2500	3.31	16.56	22	0.57
Molybdenum diSilicide	8.4	450	6240	550	10.44	1700	2050	12.58	15.17	49	0.7
Nickel	13.4	200	8900	444	10.25		1455		10.58	90.7	
Niobium diBoride	8.6	650	7210	420	17.91	850	3000	10.80	38.10	0.12	17
Niobium diSilicide	8.5		5690			900	2050				0.5
Niobium Carbide	7.4	450	7820	290	12.26	650	3500	5.65	30.42	14	0.19
PTFE	220	1.3	2130	1024	32.54		200		4.62	140	10e22
Silicon	3.0	162	2330	705	1.00	1410	1410	1	1	149	2300
Silicon Carbide	4.7	304	3440	669	3.29		2700		6.30	90	0.5
Tantalum Carbide	6.7	510	14500	190	9.37	650	3900	4.32	25.93	23	0.35
Tantalum diBoride	8.5	250	12600	250	6.47	850	3090	3.90	14.17	16	0.14
Tantalum diSilicide	9.5		9080	360		800	2670				0.46
Titanium Carbide	7.4	462	4920	480	12.08	700	3160	6.00	27.08	17.2	1.55
Titanium diBoride	8.2	575	4450	632	15.51	1400	3253	15.40	35.78	26.4	0.13
Titanium diSilicide	10.7	270	4100	480	17.72	1300	1540	16.34	19.35	46	0.145
Titanium Nitride	9.4	600	5450	636	17.25	500	2950	6.12	36.10	30	1.35
Tungsten Boride	5.0	790	13100	460	3.70	1000	2365	2.62	6.20	52	0.19
Tungsten Carbide	5.2	690	15800	200	6.66	500	2780	2.36	13.13	29	0.2
Tungsten diSilicide	7.0	300	9750	330	5.15	1200	2165	4.39	7.91	48	33e10
Vanadium diBoride	7.6	260	5100	670	4.96	600	2430	2.11	8.54	42	0.13
Vanadium Carbide	6.7	420	5480	530	7.32	600	2730	3.12	14.18	10	0.59
Vanadium diSilicide	11.2		5100			1000	1700			25	0.66
Vanadium Nitride	8.1	460	6080	630	8.89	450	2170	2.84	13.68	5.2	0.85
Zirconium Carbide	6.3	410	6560	250	11.19	600	3440	4.76	27.31	22	0.42
Zirconium diBoride	5.9	340	6170			1300	3245			58	0.15
Zirconium diSilicide	8.7	270	4900			1150	1600			15	0.76
Zirconium Nitride	5.9	500	7350	400	6.68	500	2950	2.37	13.97	10	0.2-0.3

Where:

 γ = Coefficient of thermal expansion.

E = Young's Modulus,

5 ρ = density,

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C = specific heat capacity,

O.T. = Oxidizing temperature,

M.T. = Melting Temperature,

m_e = Efficiency Slope (normalized to Silicon m_e value, normalized Silicon value $m_{(r,e)}$ =

5 0.8865e-06),

ϵ_c = Material Index (normalized to Silicon ϵ value, normalized Silicon ϵ_r = 1.25e-03),

KXX = thermal conductivity, and

R = resistivity.

Comparison 1

10 The mechanical work and heat input between a material and silicon for a constant beam volume is compared. Thus, Comparison 1 calculates the maximum possible relative work and associated relative heat input required due to a direct material substitution. Details of the comparison for different materials are included in Table 3 which shows that CVD ceramics are far superior actuator materials than silicon (Table 3 is formulated using melting point and Table 4 is formulated using oxidation temperature). Titanium nitride can output 159.3 times more the amount of mechanical work than silicon with only 4.41 times the amount of heat input. The factor in equation 8 and the scaled material efficiency ratio (as included in Table 2) repeatedly occur in the following comparisons illustrating the versatility of the method.

20

$$\frac{W_c}{W_r} = \frac{\epsilon_c Q_c}{\epsilon_r Q_r} = \frac{\epsilon_c}{\epsilon_r} \left(\frac{\rho_c C_c T_c}{\rho_r C_r T_r} \right) \quad (EQ7)$$

The r subscript denotes the reference material which is silicon in this case. The c subscript denotes the compared material.

25

$$\frac{Q_c}{Q_r} = \left(\frac{\rho_c C_c T_c}{\rho_r C_r T_r} \right) \quad (EQ8)$$

Comparison 2

Different materials increase in temperature by different amounts when subjected to the same quantity of heat energy for a constant volume. The material volume is scaled relative to the silicon volume according to the constraints that the same amount of silicon heat

30 energy is input to both actuators and the compared material attains its operational temperature. Thus, the actuation efficiency value remains unchanged because it is not a

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function of volume and the operable temperature is reached (as equation 5 shows).

Comparison 2 represents the design case where heat and volume are critical factors.

The scaled volume and output mechanical work are calculated using equations 9 and 10. The volume change is typically implemented by modifying one geometric dimension, i.e. length, width or thickness. Titanium nitride is capable of 36.1 times the amount of work that silicon is capable with the same heat energy input but with only 0.23 times the volume. Equation 9 is the inverse of equation 8 and equation 10 is simply the scaled efficiency number as included in Table 2.

$$Q_r = V_r \rho_r C_r T_r = Q_c = V_c \rho_c C_c T_c \Rightarrow \frac{V_{(c, Q_r)}}{V_r} = \frac{\rho_r C_r T_r}{\rho_c C_c T_c} \quad (EQ 9)$$

The first entry of the bracketed subscript in these equations refers to the material that the beam is constructed from. The second entry refers to the constraining variable for the described parameter. For example - $W_{(c, V_c)}$ = Mechanical work output from beam constructed of compared material with a volume of V_c .

$$\frac{W_{(c, V_c)}}{W_{(r, V_r)}} = \frac{\varepsilon_c Q_r}{\varepsilon_r Q_r} = \frac{\varepsilon_c}{\varepsilon_r} \quad (EQ 10)$$

Comparison 3

The output mechanical work resulting from silicon heat energy for constant volume beams is compared. The operation temperature and efficiency value for the compared material changes. However, the new efficiency is easily calculated using a multiplicative ratio of the new and old operation temperatures because of the linear relationship between temperature and efficiency (as shown in Figure 3). The new operation temperature and work are given by equations 11 and 12. This comparison represents the design case where heat is a critical parameter.

PTFE will melt when subjected to the input silicon heat value. Titanium disilicide outperforms titanium nitride mainly because of the higher computed operating temperature (Table 3).

$$Q_r = V_r \rho_r C_r T_r = Q_c = V_c \rho_c C_c T_{(c, Q_r)} \Rightarrow T_{(c, Q_r)} = T_r \left(\frac{\rho_r C_r}{\rho_c C_c} \right) \quad (EQ 11)$$

Comparison 4

$$\frac{W_{(c, Q_r)}}{W_{(r, Q_r)}} = \frac{\varepsilon_{(r, Q_r)} Q_r}{\varepsilon_r Q_r} = \frac{T_{(c, Q_r)} \varepsilon_2}{T_c \varepsilon_r} = \left(\frac{\rho_r C_r T_r}{\rho_c C_c T_c} \right) \frac{\varepsilon_c}{\varepsilon_r} \quad (EQ 12)$$

The material volume is scaled with respect to the silicon volume according to the constraint that the compared material operation temperature and silicon work are maintained. Thus, if the silicon work value is less then the original work then the volume is scaled down.

5 Otherwise the volume is increased as is the case for PTFE or amorphous Silicon Dioxide. The material actuation efficiency reoccurs in the calculations as an inverse as shown in equation 14

Titanium nitride can output the same amount of work as silicon but with a volume that is less than two orders of magnitude smaller with an input heat energy that is less than an 10 order smaller.

$$W_r = V_r E_r \gamma_r^2 T_r^2 = W_c = V_c E_c \gamma_c^2 T_c^2 \Rightarrow \frac{V_{(c,W_r)}}{V_r} = \frac{E_r \gamma_r^2 T_r^2}{E_c \gamma_c^2 T_c^2} \quad (EQ 13)$$

$$\frac{Q_{(c,V_r)}}{Q_{(r,V_r)}} = \frac{\varepsilon_r W_r}{\varepsilon_c W_r} = \frac{\varepsilon_r}{\varepsilon_c} \quad (EQ 14)$$

15

Comparison 5

The input heat energy required to output silicon mechanical work for constant volume beams is compared. The operation temperature and thus efficiency value for the compared material changes. The new efficiency can be calculated in an identical fashion to that 20 described in comparison 3. The operational temperature and heat input values are calculated using equations 15 and 16.

The table shows that titanium disilicide slightly outperforms titanium nitride whereas both PTFE and silicon dioxide will melt. The CVD ceramics are again shown to have the best performance.

25

$$W_r = V_r E_r \gamma_r^2 T_r^2 = W_c = V_c E_c \gamma_c^2 T_c^2 \Rightarrow T_{(c,W_r)} = \left(\frac{\gamma_r}{\gamma_c} \right) \sqrt{\frac{E_r}{E_c}} \quad (EQ 15)$$

$$\frac{Q_{(r,W_r)}}{Q_{(r,W_r)}} = \frac{\varepsilon_r W_r}{\varepsilon_{(c,Q_r)} W_r} = \frac{\varepsilon_r T_c}{\varepsilon_c T_{(c,Q_r)}} = \frac{\varepsilon_r T_c \gamma_c}{\varepsilon_c T_r \gamma_r} \sqrt{\frac{E_c}{E_r}} \quad (EQ 16)$$

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TABLE 3 Design comparisons for materials included in Table 2. Comparisons are done using melting point temperature

Constant	Comparison 1		Comparison 2		Comparison 3		Comparison 4		Comparison 5	
	V	Q	V, Q	W	V, W	W	V, W	W	V, W	W
	Q_r/Q_r	W_c/W_r	$V_{c,QR}/V_{r,QR}$	$W_{c,Vr}/W_{r,Vr}$	$T_{c,QR}/W_{(r,QR)}$	$V_{c,WR}/W_{(r,VR)}$	$Q_{c,VR}/Q_{r,VR}$	$T_{c,WR}/Q_{(r,WR)}$	$V_{c,WR}/Q_{(r,WR)}$	$T_{c,WR}/Q_{(r,WR)}$
Aluminum	0.69	5.48	1.46	7.98	$>T_{melt}$		0.183	0.125	280.79	0.29
Boron Carbide	2.55	19.06	0.39	7.49	962.41	2.94	0.053	0.133	561.51	0.58
Chromium diBoride	3.59	106.23	0.28	29.62	599.41	8.26	0.009	0.0330	208.73	0.35
Chromium Carbide	2.90	46.80	0.35	16.16	654.20	5.58	0.021	0.062	277.16	0.42
Chromium Oxide	4.27	19.34	0.23	4.52	608.98	1.06	0.052	0.221	592.32	0.97
Copper	1.62	12.18	0.62	7.53	671.18	4.66	0.082	0.132	311.11	0.46
Gold	1.14	6.31	0.87	5.52	930.29	4.82	0.159	0.181	423.90	0.46
Hafnium Carbide	4.08	86.81	0.24	21.25	962.13	5.20	0.012	0.047	422.05	0.44
Molybdenum	2.90	18.78	0.34	6.48	904.67	2.23	0.053	0.154	605.63	0.67
Molybdenum Boride	3.66	27.09	0.27	7.40	584.23	2.02	0.037	0.135	411.42	0.70
Molybdenum Carbide	3.10	51.36	0.32	16.56	806.23	5.34	0.019	0.061	349.05	0.43
Molybdenum diSilicide	3.04	46.09	0.33	15.17	674.86	4.99	0.022	0.066	302.14	0.45
Nickel	2.48	26.26	0.40	10.58	586.13	4.26	0.038	0.095	284.10	0.48
Niobium diBoride	3.92	149.44	0.25	38.10	764.86	9.71	0.007	0.026	245.55	0.32

TABLE 3 Design comparisons for materials included in Table 2. Comparisons are done using melting point temperature

Constant	Comparison 1		Comparison 2		Comparison 3		Comparison 4		Comparison 5	
	V	Q	V,Q	V,Q	W	W	V,W	V,W	T _(c,W_r)	Q _(c,W_r)
	Q _r /Q _r	W _c /W _r	V _{(c,Q_r)/V_(r,Q_r)}	W _{(c,V_c)/W_(r,V_r)}	T _(c,Q_r)	W _{(c,Q_r)/W_(r,Q_r)}	V _{(c,W_r)/V_(r,V_r)}	Q _{(c,V_c)/Q_(r,V_r)}	T _(c,W_r)	Q _(c,W_r)
Niobium Carbide	3.43	104.26	0.29	30.42	1021.31	8.88	0.010	0.032	342.97	0.34
PTFE	0.19	0.87	5.31	4.62	>T _{melt}		1.152	0.216		
Silicon	1.00	1.00	1.00	1	1410.00	1.00	1.000	1	1410.00	1.00
Silicon Carbide	2.68	16.91	0.37	6.30	1006.42	2.35	0.059	0.158	657.00	0.65
Tantalum Carbide	4.64	120.27	0.22	25.93	840.70	5.59	0.008	0.038	355.83	0.42
Tantalum diBoride	4.20	59.57	0.24	14.17	735.28	3.37	0.017	0.071	400.60	0.54
Titanium	1.70	7.27	0.59	4.28	984.12	2.52	0.138	0.234	619.87	0.63
Titanium diBoride	3.95	141.32	0.25	35.78	823.54	9.06	0.007	0.028	273.81	0.33
Titanium diSilicide	1.31	25.32	0.76	19.35	1176.90	14.79	0.040	0.0517	306.22	0.26
Titanium Nitride	4.41	159.36	0.23	36.10	668.21	8.18	0.006	0.0277	233.83	0.35
Tungsten Boride	6.15	38.16	0.16	6.20	384.36	1.01	0.026	0.161	383.10	1.00
Tungsten Carbide	3.79	49.80	0.26	13.13	732.95	3.46	0.020	0.076	394.10	0.54
Tungsten diSilicide	3.01	23.80	0.33	7.91	719.86	2.63	0.042	0.126	444.06	0.62
Vanadium diBoride	3.58	30.63	0.28	8.54	677.83	2.38	0.033	0.117	439.34	0.65

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TABLE 3 Design comparisons for materials included in Table 2. Comparisons are done using melting point temperature

Constant	Comparison 1		Comparison 2		Comparison 3		Comparison 4		Comparison 5	
	V	Q	V,Q	W	V,Q	W	V,W	V,W	V,W	V,W
	Q_r/Q_c	W_c/W_r	$V_{(c, Q_r)}/V_{(r, Q_r)}$	$W_{(c, V_c)}/W_{(r, V_r)}$	$T_{(c, Q_r)}/W_{(r, Q_r)}$	$V_{(c, Q_r)}/W_{(r, V_r)}$	$Q_{(c, V_c)}/Q_{(r, V_r)}$	$T_{(c, V_c)}/V_{(r, V_r)}$	$T_{(c, W_r)}/Q_{(r, W_r)}$	$Q_{(c, W_r)}/Q_{(r, W_r)}$
Vanadium Carbide	3.42	48.53	0.29	14.18	797.46	4.14	0.021	0.071	392.10	0.49
Vanadium Nitride	3.59	49.09	0.28	13.68	604.67	3.81	0.020	0.0731	309.91	0.51
Zirconium Carbide	2.44	66.51	0.41	27.31	1412.28	11.21	0.015	0.0366	422.05	0.30
Zirconium Nitride	3.74	52.32	0.27	13.97	787.80	3.73	0.019	0.0716	408.09	0.52

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TABLE 4 Design comparisons for material included in Table 2. Comparisons are done using oxidation temperature

Constant	Comparison 1		Comparison 2		Comparison 3		Comparison 4		Comparison 5	
	V	Q	V, Q	W	V, W	W	V, W	W	V, W	W
	Q_c/Q_r	W_c/W_r	$V_{(c,Q_r)}/V_{(r,Q_r)}$	$W_{(c,V_r)}/W_{(r,V_r)}$	$T_{(c,Q_r)}$	$W_{(c,Q_r)}/W_{(r,Q_r)}$	$V_{(c,W_r)}/V_{(r,W_r)}$	$Q_{(c,V_r)}/Q_{(r,V_r)}$	$T_{(c,W_r)}$	$Q_{(c,W_r)}/Q_{(r,W_r)}$
Vanadium diBoride	0.885	1.864	1.13	2.10	>T oxid.		0.326	0.475	439.337	0.648
Vanadium Carbide	0.752	2.341	1.33	3.11	>T oxid.		0.26	0.32	392.1	0.49
Vanadium Nitride	0.74	2.1	1.34	2.83	>T oxid.		0.289	0.353	309.9	0.513
Zirconium Carbide	0.425	2.02	2.35	4.75	>T oxid.		0.301	0.21	422.05	0.299
Zirconium Nitride	0.64	1.5	1.57	2.36	>T oxid.		0.405	0.423	408.1	0.518

A Thermoelastic Actuator

A hot arm/cold arm actuator is presented in Figure 1 to illustrate the results contained in Table 3. Only the steady state solution for a quantity of heat input to the heater is analyzed. The device comprises two identical material layers separated by air and connected to each other at the ends by a thermally non-conductive block. The force/deflection characteristics of the output mechanical power can be tuned by altering the separation between the two layers. A greater separation increases the transverse force but decreases deflection.

Two actuators constructed from titanium and silicon are compared using graphed energy results in Figure 4. Five design comparisons for Titanium are plotted according to the results contained in Table 3. The relationship between volumes, mechanical work and heat energy are identical to those included in Table 3. Titanium volumes are scaled using length for Comparisons 2 and 4.

Discussion

The combination of five separate material properties is important in assessing a material's potential for thermoelastic design and materials with one predominant property have been shown to not necessarily be the best candidate. This is evident in both Table 3 for PTFE (high g) and diamond (high E). Both gold and copper have high g values but are hindered as good candidates by low E and high r values. Silicon is very inefficient compared to certain other materials, however, amorphous silicon dioxide is possibly the most inefficient material of all.

Output mechanical work, input heat energy and actuator volume are three essential characterizing parameters for thermoelastic design. The design method described incorporates these parameters using only material properties and provides a structured approach for material selection. The method is versatile because the approach assesses the potential of a material using easily calculated comparison ratios. It is important to note that the approach is a measure of a materials potential and must be used as a tool in conjunction with other appropriate design criteria. For example, criteria such as force/deflection characteristics of the output work, material resistivity, environmental ruggedness and material availability may be important. The operable temperature range is assumed to be from 0 degrees to the melting point on the Centigrade scale because it is indicative of the

material thermal range. However, the maximum operable temperature could be different due to oxidation of the material or other thermal design constraints. Titanium nitride has close to the highest actuation efficiency value when melting point is used as a criteria. However, Titanium diSilicide is potentially a better candidate for use when oxidation temperature is 5 used. Titanium nitride is a practical candidate because it is well established as a CMOS barrier material. The oxidation temperature of TiN can be raised from 500 °C to 900 °C by alloying with aluminum. The alloyed material has a symbol (Ti,Al)N.

10 The actuation efficiency of a simple thermoelastic titanium beam is low compared to other actuation mechanisms (less than 1 percent). It is theoretically possible to get a thermoelastic actuation efficiency of about 4.5 percent for a simple titanium nitride beam, however, this value typically decreases when the material is implemented in a MEMS device due to associated operational losses (for example - thermal conduction into the substrate).

15 The invention has been described herein by way of example only. Skilled workers in this field will readily recognise many variations and modifications which do depart from the spirit and scope of the broad inventive concept.

CLAIMS:

1. A method of selecting a material for use as the expansive element in a thermoelastic design by deriving an indicator of the material's potential effectiveness for that use, said method including the step of calculating a dimensionless constant $\epsilon\gamma$ for that material in accordance with the formula:

$$\epsilon\gamma = \frac{E\gamma^2 T}{\rho C}$$

wherein E is the Young's modulus of the material; γ is the coefficient of thermal expansion; T is the maximum operating temperature, ρ is the density and C is the specific heat capacity.

10 2. The method of Claim 1 further including the step of normalising the dimensionless constant relative to that of silicon to a value ϵ which is achieved by deriving the value $\epsilon\gamma$ for the material of interest at the relevant temperature value and dividing this by the value of ϵ obtained for silicon at that same temperature.

15 3. The method of Claim 1 further including the step of eliminating certain materials by requiring a pre-determined resistivity range.

20 4. The method of Claim 3 further wherein the resistivity range is between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$.

25 5. An expansive element in a thermoelastic design that is made from any functionally suitable material or combinations of materials selected from a group including: silicides and carbides of titanium.

6. An expansive element according to Claim 5 further including one or more of the following properties:

30 (e) a resistivity between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$;
(f) chemically inert in air;

- (g) chemically inert in the chosen ink; and
- (h) depositable by CVD, sputtering or other thin film deposition technique.

7. An expansive element in a thermoelastic design that is made from any functionally suitable material or combinations of materials selected from a group including:
5 borides, silicides, carbides and nitrides of tantalum, molybdenum, niobium, chromium, tungsten, vanadium, and zirconium.

8. An expansive element according to Claim 7 further including one or more of the
10 following properties:

- (i) a resistivity between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$;
- (j) chemically inert in air;
- (k) chemically inert in the chosen ink; and
- (l) depositable by CVD, sputtering or other thin film deposition technique.

15

9. An expansive element in a thermoelastic design that is made from any functionally suitable alloy material or combinations of alloy materials selected from the group including:
borides, silicides, carbides and nitrides of titanium, tantalum, molybdenum, niobium, chromium, tungsten, vanadium, and zirconium.

20

10. An expansive element according to Claim 9 further including one or more of the following properties:

- (m) a resistivity between $0.1\mu\Omega\text{m}$ and $10.0\mu\Omega\text{m}$;
- (n) chemically inert in air;
- (o) chemically inert in the chosen ink; and
- (p) depositable by CVD, sputtering or other thin film deposition technique.

25

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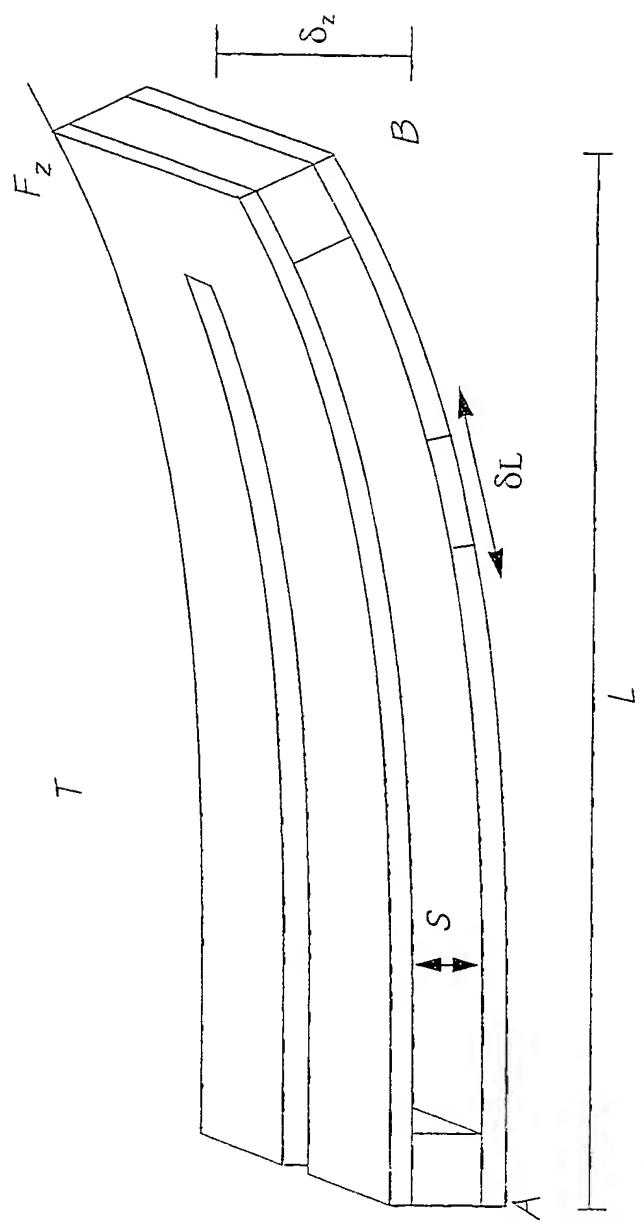


FIG. 1

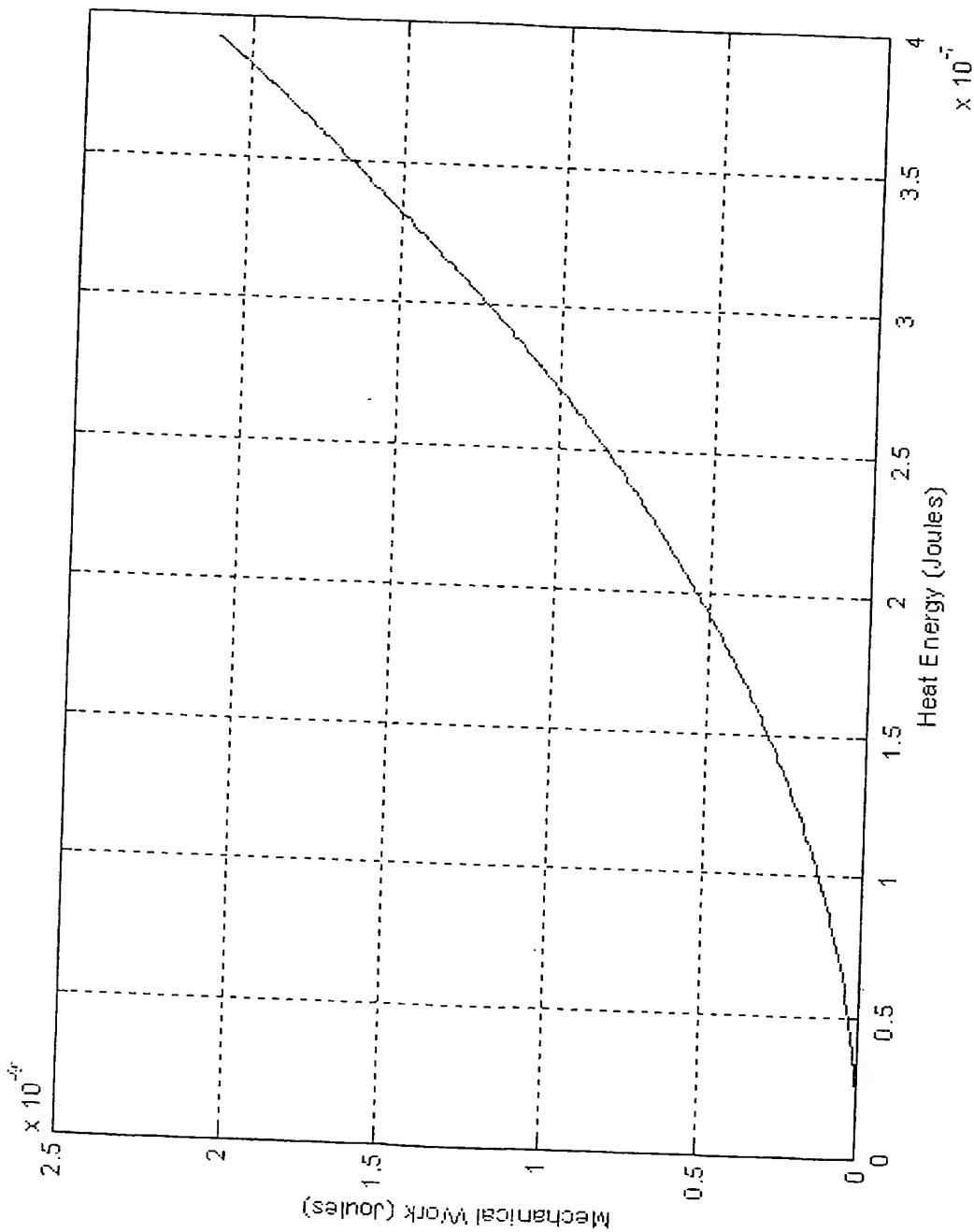


Fig. 2

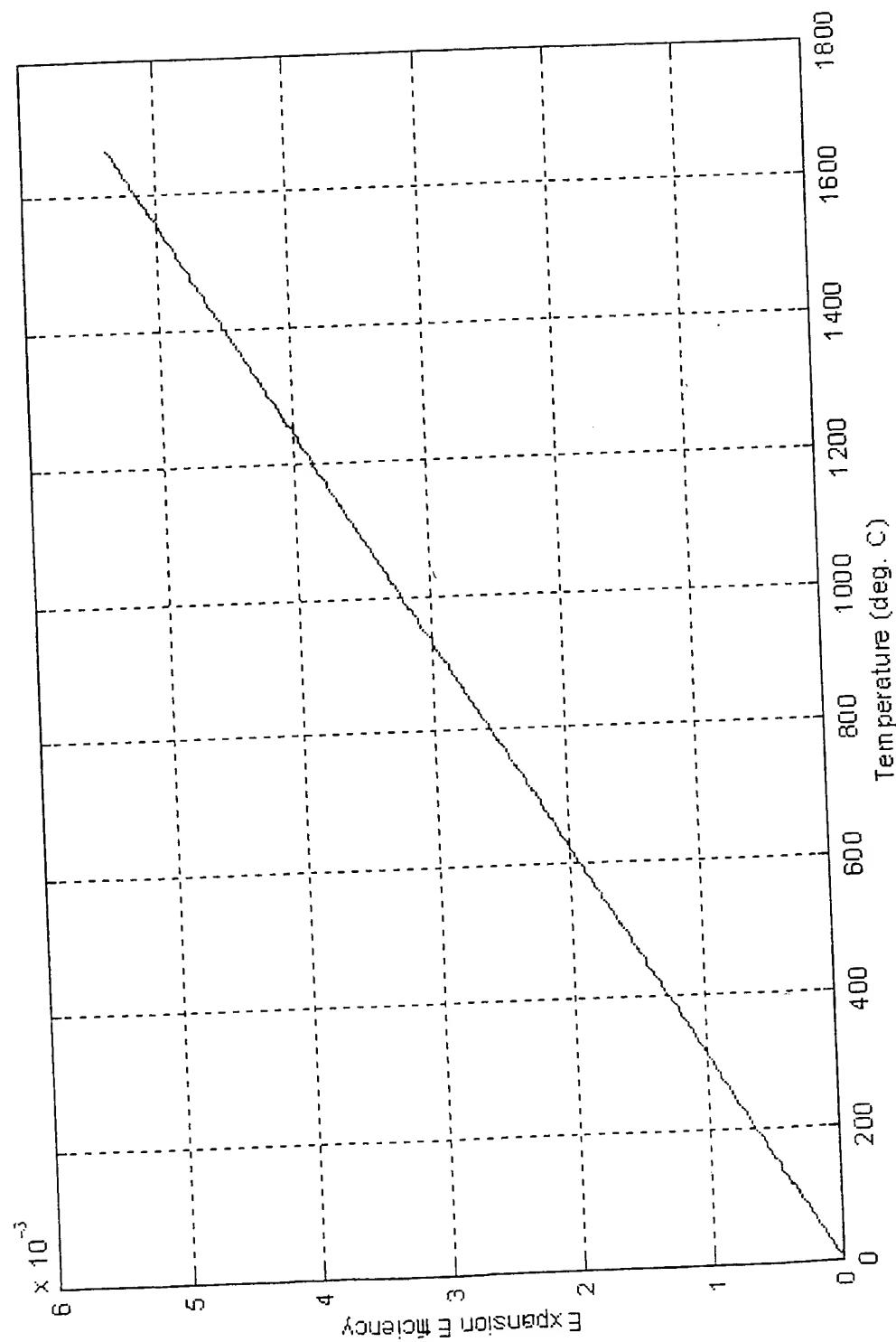


Fig. 3

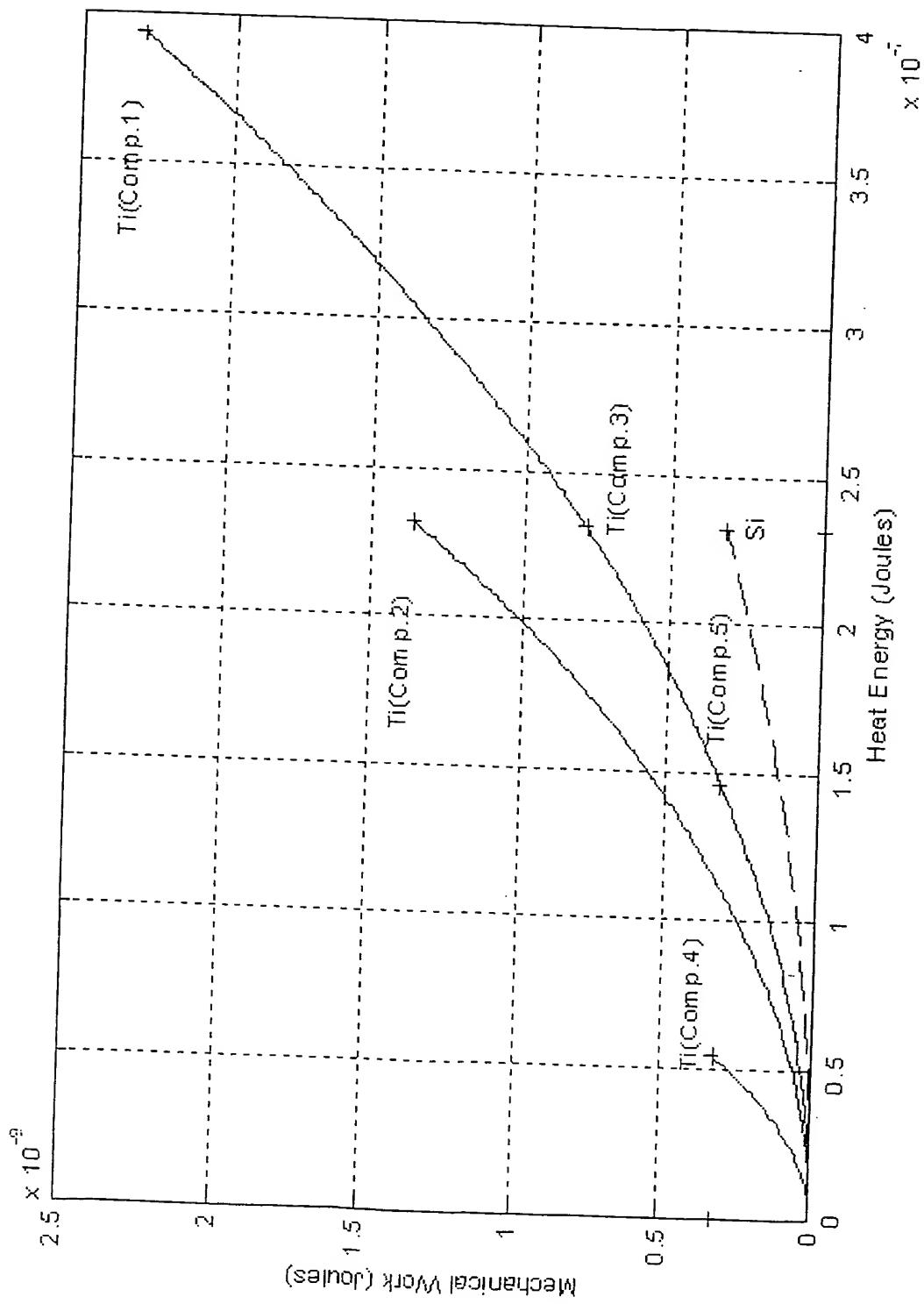


Fig. 4

INTERNATIONAL SEARCH REPORT

International application No.

PCT/AU01/01332

A. CLASSIFICATION OF SUBJECT MATTER

Int. Cl. ⁷: B81C 1/00, B81B 7/02, B41J 2/045, H02N 10/00

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

Refer electronic data base below

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

AU: IPC H02N 10/00

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

DWPI & keywords.) See extra sheet

ESP@CE & keywords.)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	WO 9903681 A (SILVERBROOK RESEARCH PTY LIMITED) 28 January 1999 See whole document, particularly pages 100-137, figures 320-614.	9, 10 1-8
A	See whole document.	
X	WO 200023279 A (SILVERBROOK RESEARCH PTY LIMITED) 27 April 2000 See whole document, particularly pages 21-29.	9, 10
X	WO 200055089 A (SILVERBROOK RESEARCH PTY LTD) 21 September 2000 See whole document, particularly pages 10-13.	9, 10

Further documents are listed in the continuation of Box C See patent family annex

* Special categories of cited documents:	
"A" document defining the general state of the art which is not considered to be of particular relevance	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
"E" earlier application or patent but published on or after the international filing date	"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)	"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
"O" document referring to an oral disclosure, use, exhibition or other means	"&" document member of the same patent family
"P" document published prior to the international filing date but later than the priority date claimed	

Date of the actual completion of the international search
25 January 2002

Date of mailing of the international search report

- 5 FEB 2002

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INTERNATIONAL SEARCH REPORT

International application No.

PCT/AU01/01332

C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
P,X	US 20010008406 A (SILVERBROOK) 19 July 2001 See whole document, particularly page 6 paragraphs 0111-0113	7-10
P,X	WO 200064805 A (SILVERBROOK RESEARCH PTY LTD) 2 November 2000 See whole document	9, 10

INTERNATIONAL SEARCH REPORT

International application No.

PCT/AU01/01332

Box I Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)

This international search report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:

1. Claims Nos :
because they relate to subject matter not required to be searched by this Authority, namely:

2. Claims Nos :
because they relate to parts of the international application that do not comply with the prescribed requirements to such an extent that no meaningful international search can be carried out, specifically:

3. Claims Nos :
because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a)

Box II Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

This International Searching Authority found multiple inventions in this international application, as follows:

Independent claims 1, 5, 7 and 9 relate to three different inventions. See extra sheet for details.

1. As all required additional search fees were timely paid by the applicant, this international search report covers all searchable claims
2. As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3. As only some of the required additional search fees were timely paid by the applicant, this international search report covers only those claims for which fees were paid, specifically claims Nos.:

4. No required additional search fees were timely paid by the applicant. Consequently, this international search report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:

Remark on Protest The additional search fees were accompanied by the applicant's protest. No protest accompanied the payment of additional search fees.

INTERNATIONAL SEARCH REPORT

International application No.

PCT/AU01/01332

Supplemental Box

(To be used when the space in any of Boxes I to VIII is not sufficient)

Continuation of Box No: II Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

The international application does not comply with the requirements of unity of invention because it does not relate to one invention or to a group of inventions so linked as to form a single general inventive concept. In coming to this conclusion the International Searching Authority has found that there are different inventions as follows:

1. Claims 1-4 define a method of selecting a material for use as an expansive element using a calculated indicator. It is considered that the formula for calculating the indicator comprises a first "special technical feature".
2. Claims 5, 6, 9 and 10 define an expansive element selected from a group of functionally suitable materials including silicides and carbides of titanium. It is considered that use of these materials comprises a second "special technical feature".
3. Claims 7-10 define an expansive element selected from a group of functionally suitable materials including borides, silicides, carbides and nitrides of tantalum, molybdenum, niobium, chromium, tungsten, vanadium and zirconium. It is considered that use of these materials comprises a third "special technical feature".

These groups are not so linked as to form a single general inventive concept, that is, they do not have any common inventive features, which define a contribution over the prior art. The common concept linking together these groups of claims is the basic concept of selecting functionally suitable materials. Therefore these claims lack unity a posteriori.

Continuation of B:

FIELDS SEARCHED:

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

DWPI & keywords: thermoelastic, Young's modulus, coefficient, formula, MEMS, titanium, tantalum, molybdenum, niobium, chromium, tungsten, vanadium, zirconium, boride, silicide, carbide, nitride and similar terms.

ESP@CE ECLA H01H1/00M & keywords: modulus, coefficient, formula, titanium, tantalum, molybdenum, niobium, chromium, tungsten, vanadium, zirconium, boride, silicide, carbide, nitride

INTERNATIONAL SEARCH REPORT
Information on patent family members

International application No.
PCT/AU01/01332

This Annex lists the known "A" publication level patent family members relating to the patent documents cited in the above-mentioned international search report. The Australian Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

Patent Document Cited in Search Report				Patent Family Member	
WO	9903681	AU	83238/98	EP	999934
WO	200023279	AU	11391/00	EP	1121249
WO	200055089	AU	28972/00	EP	1171378
US	20010008406		NIL		
WO	200064805	AU	40915/00		

END OF ANNEX

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